

## TIS/MADRID ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.1

MADRID ID: MD270770

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	CHANGE OF ADDRESS
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
STMicroelectronics International N.V.	07/07/2023
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	STMicroelectronics International N.V.
<b>Address:</b>	Chemin du Champ des Filles 39 Plan-les-Ouates CH-1228 Geneva
<b>Country:</b>	CH
<b>Entity Type:</b>	N.V.
<b>Entity Country:</b>	The Netherlands
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Serial Number:</b>	79137343
<b>CORRESPONDENCE DATA</b>	
<b>Correspondent Name:</b>	STMicroelectronics International N.V.
<b>Address:</b>	Chemin du Champ des Filles 39 Plan-les-Ouates CH-1228 Geneva
<b>Country:</b>	CH

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